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FAIRCHILD SEMICONDUCTOR®

June 2011

NC7WZ14
TinyLogic® UHS Dual Inverter with Schmitt Trigger Inputs

Features

- Ultra-High Speed: t_{PD} 3.2ns (Typical) into 50pF at 5V V_{CC}
- High Output Drive: ±24mA at 3V V_{CC}
- Broad V_{CC} Operating Range: 1.65V to 5.5V
- Matches Performance of LCX when Operated at 3.3V V_{CC}
- Power Down High Impedance Inputs/Outputs
- Over-Voltage Tolerance Inputs Facilitate 5V to 3V Translation
- Proprietary Noise/EMI Reduction Circuitry
- Ultra-Small MicroPak™ Packages
- Space-Saving SC70 Package

Description

The NC7WZ14 is a dual inverter with Schmitt trigger input from Fairchild's Ultra-High Speed (UHS) Series of TinyLogic. The device is fabricated with advanced CMOS technology to achieve ultra-high speed with high output drive while maintaining low static power dissipation over a very broad V_{CC} operating range. The device is specified to operate over the 1.65V to 5.5V V_{CC} range. The inputs and outputs are high-impedance when V_{CC} is 0V. Inputs tolerate voltages up to 7V independent of V_{CC} operating voltage. Schmitt trigger inputs achieve typically 1V hysteresis between the positive-and negative-going input threshold voltage at 5V.

Ordering Information

Part Number	Operating Temperature	Top Mark	Package	Packing Method
NC7WZ14P6X	-40 to +85°C	Z14	6-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3000 Units on Tape & Reel
NC7WZ14EP6X	-40 to +125°C	Z14	6-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3000 Units on Tape & Reel
NC7WZ14L6X	-40 to +85°C	A9	6-Lead MicroPak™, 1.00mm Wide	5000 Units on Tape & Reel
NC7WZ14FHX	-40 to +85°C	A9	6-Lead, MicroPak2, 1x1mm Body, .35mm Pitch	5000 Units on Tape & Reel

Connection Diagrams

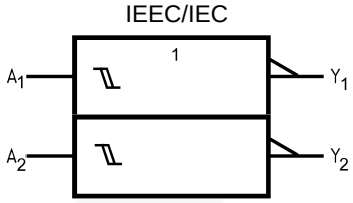


Figure 1. Logic Symbol

Pin Configurations

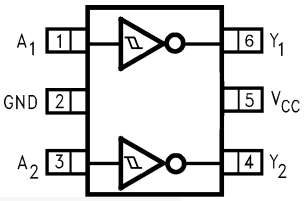


Figure 2. SC70 (Top View)

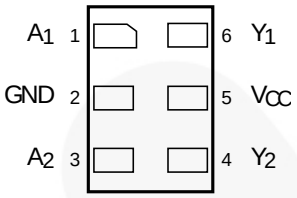
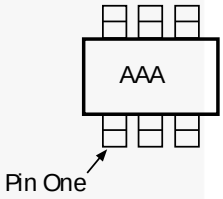


Figure 3. MicroPak (Top Through View)



Notes:
1. AAA represents Product Code Top Mark (*see ordering code).*
2. Orientation of Top Mark determines Pin One location. Read the top product code mark left to right. Pin One is the lower left pin.

Figure 4. SC70 Pin 1 Orientation

Pin Definitions

Pin # SC70	Pin # MicroPak	Name	Description
1	1	A_1	Input
2	2	GND	Ground
3	3	A_2	Input
4	4	Y_2	Output
5	5	V_{CC}	Supply Voltage
6	6	Y_1	Output

Function Table

Y= /A

Inputs	Output
A	**Y**
L	H
H	L

H = HIGH Logic Level

L = LOW Logic Level

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter			Min.	Max.	Unit
V_{CC}	Supply Voltage			-0.5	7.0	V
V_{IN}	DC Input Voltage			-0.5	7.0	V
V_{OUT}	DC Output Voltage			-0.5	7.0	V
I_{IK}	DC Input Diode Current	V_{IN} < -0.5V			-50	mA
I_{OK}	DC Output Diode Current	V_{OUT} < -0.5V			-50	mA
I_{OUT}	DC Output Current				±100	mA
I_{CC} or I_{GND}	DC V_{CC} or Ground Current				±50	mA
T_{STG}	Storage Temperature Range			-65	+150	°C
T_J	Junction Temperature Under Bias				+150	°C
T_L	Junction Lead Temperature (Soldering, 10 Seconds)				+260	°C
P_D	Power Dissipation	SC70-6	T_A=85°C		170	mW
			T_A=125°C		104	
		MicroPak-6			130	
		MicroPak2-6			120	
ESD	Human Body Model, JEDEC:JESD22-A114				4000	V
	Charge Device Model, JEDEC:JESD22-C101				2000	

Recommended Operating Conditions[3]

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Conditions	Min.	Max.	Unit
V_{CC}	Supply Voltage Operating		1.65	5.50	V
	Supply Voltage Data Retention		1.5	5.5	
V_{IN}	Input Voltage		0	5.5	V
V_{OUT}	Output Voltage		0	V_{CC}	V
T_A	Operating Temperature	SC70-6	-40	+125	°C
		MicroPak-6	-40	+85	
		MicroPak2-6	-40	+85	
θ_{JA}	Thermal Resistance	SC70-6		390	°C/W
		MicroPak-6		500	
		MicroPak2-6		560	

Note:

3. Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

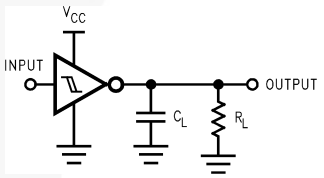
Symbol	Parameter	V_{CC} (V)	Conditions	T_A=+25°C			T_A=-40 to +85°C		T_A=-40 to +125°C		Units
				Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
V_P	Positive Threshold Voltage	1.65		0.60		1.40	0.60	1.40	0.60	1.40	V
		1.80		0.70		1.50	0.70	1.50	0.70	1.50	
		2.30		1.00		1.80	1.00	1.80	1.00	1.80	
		3.00		1.30		2.20	1.30	2.20	1.30	2.20	
		4.50		1.90		3.10	1.90	3.10	2.00	3.20	
		5.50		2.20		3.60	2.20	3.60	2.30	3.70	
V_N	Negative Threshold Voltage	1.65		0.20	0.50	0.80	0.20	0.80	0.30	0.90	V
		1.80		0.25	0.56	0.90	0.25	0.90	0.35	1.00	
		2.30		0.40	0.75	1.15	0.40	1.15	0.50	1.20	
		3.00		0.60	0.98	1.50	0.60	1.50	0.70	1.60	
		4.50		1.00	1.42	2.00	1.00	2.00	1.10	2.20	
		5.50		1.20	1.68	2.30	1.20	2.30	1.40	2.50	
V_H	Hysteresis Voltage	1.65		0.10	0.48	0.90	0.10	0.90	0.10	0.90	V
		1.80		0.15	0.51	1.00	0.15	1.00	0.15	1.00	
		2.30		0.25	0.62	1.10	0.25	1.10	0.25	1.10	
		3.00		0.40	0.76	1.20	0.40	1.20	0.40	1.20	
		4.50		0.60	1.01	1.50	0.60	1.50	0.60	1.50	
		5.50		0.70	1.20	1.70	0.70	1.70	0.70	1.70	
V_{OH}	HIGH Level Output Voltage	1.65	$V_{IN}=V_{IL}$, I_{OH}=-100µA	1.55	1.65		1.55		1.55		V
		1.80		1.70	1.80		1.70		1.70		
		2.30		2.20	2.30		2.20		2.20		
		3.00		2.90	3.00		2.90		2.90		
		4.50		4.40	4.50		4.40		4.40		
		1.65	I_{OH}=-4mA	1.29	1.52		1.29		1.26		
		2.30	I_{OH}=-8mA	1.90	2.14		1.90		1.80		
		3.00	I_{OH}=-16mA	2.40	2.75		2.40		2.30		
		3.00	I_{OH}=-24mA	2.30	2.62		2.30		2.20		
		4.50	I_{OH}=-32mA	3.80	4.13		3.80		3.70		
V_{OL}	LOW Level Output Voltage	1.65	$V_{IN}=V_{IH}$, I_{OL}=100µA		0.00	0.10		0.10		0.10	V
		1.80			0.00	0.10		0.10		0.10	
		2.30			0.00	0.10		0.10		0.10	
		3.00			0.00	0.10		0.10		0.10	
		4.50			0.00	0.10		0.10		0.10	
		1.65	I_{OL}=4mA		0.08	0.24		0.24		0.26	
		2.30	I_{OL}=8mA		0.10	0.30		0.30		0.32	
		3.00	I_{OL}=16mA		0.16	0.40		0.40		0.43	
		3.00	I_{OL}=24mA		0.24	0.55		0.55		0.60	
		4.50	I_{OL}=32mA		0.25	0.55		0.55		0.60	
I_{IN}	Input Leakage Current	0 to 5.5	V_{IN}=5.5V, GND			±0.1		±1.0		±2.0	µA
I_{OFF}	Power Off Leakage Current	0	V_{IN} or V_{OUT}=5.5V			1		10		20	µA
I_{CC}	Quiescent Supply Current	1.65 to 5.50	V_{IN}=5.5V, GND			1.0		10		20	µA

AC Electrical Characteristics

Symbol	Parameter	V_{CC} (V)	Conditions	T_A=+25°C			T_A=-40 to +85°C		T_A=-40 to +125°C		Units	Figure
				Min.	Typ.	Max.	Min.	Max.	Min.	Max.		
t_{PLH}, t_{PHL}	Propagation Delay	1.65	C_L=15pF, R_L=1MΩ	2.5	7.6	13.1	2.5	14.5	2.5	14.7	ns	Figure 5 Figure 6
		1.80		2.5	6.3	10.9	2.5	12.0	2.5	12.3		
		2.50 ± 0.20		1.8	4.3	7.4	1.8	8.1	1.8	8.4		
		3.30 ± 0.30		1.5	3.3	5.0	1.5	5.5	1.5	5.8		
		5.00 ± 0.50		1.0	2.7	4.1	1.0	4.5	1.0	4.8		
		3.30 ± 0.30	C_L=50pF, R_L=500Ω	1.8	4.0	6.0	1.8	6.6	1.8	6.9		Figure 5 Figure 6
		5.00 ± 0.50		1.2	3.2	4.9	1.2	5.4	1.2	5.7		
C_{IN}	Input Capacitance	0.00			2.5						pF	
C_{PD}	Power Dissipation Capacitance(4)	3.30			11.0						pF	Figure 7
		5.00			12.5							

Note:

4. C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. C_{PD} is related to I_{CCD} dynamic operating current by the expression: $I_{CCD}=(C_{PD})(V_{CC})(f_{IN})+(I_{CC}static)$.



Note:

5. CL includes load and stray capacitance; Input PRR=1.0MHz; t_W=500ns

Figure 5. AC Test Circuit

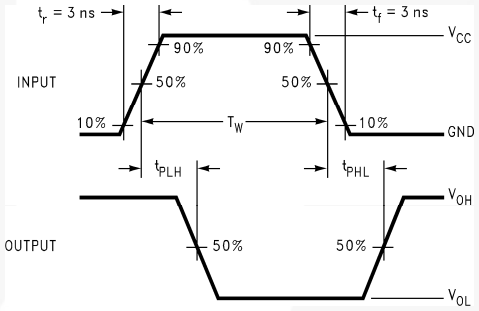
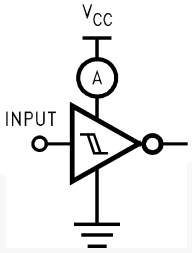


Figure 6. AC Waveforms



Note:

6. Input=AC Waveform; t_r=t_f=1.8ns; PRR=variable; Duty Cycle =50%.

Figure 7. I_{CCD} Test Circuit

Physical Dimensions

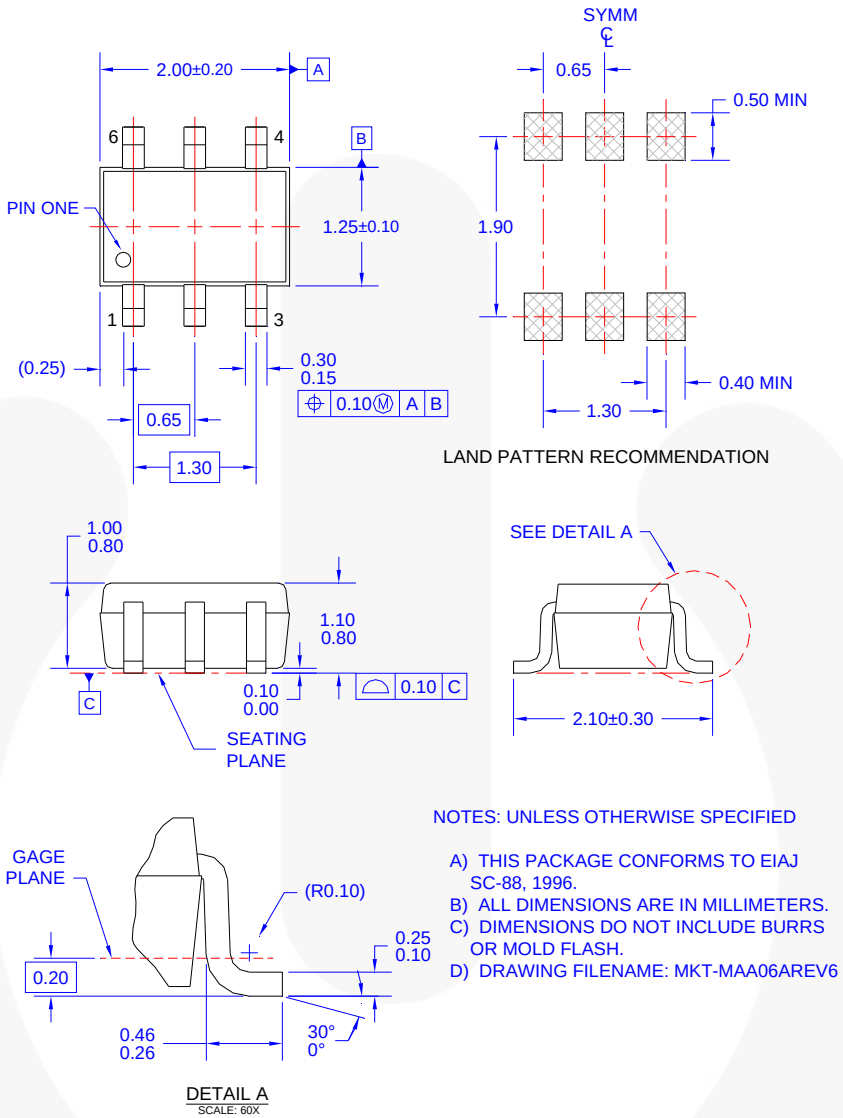


Figure 8. 6-Lead, SC70, EIAJ SC-88a, 1.25mm Wide

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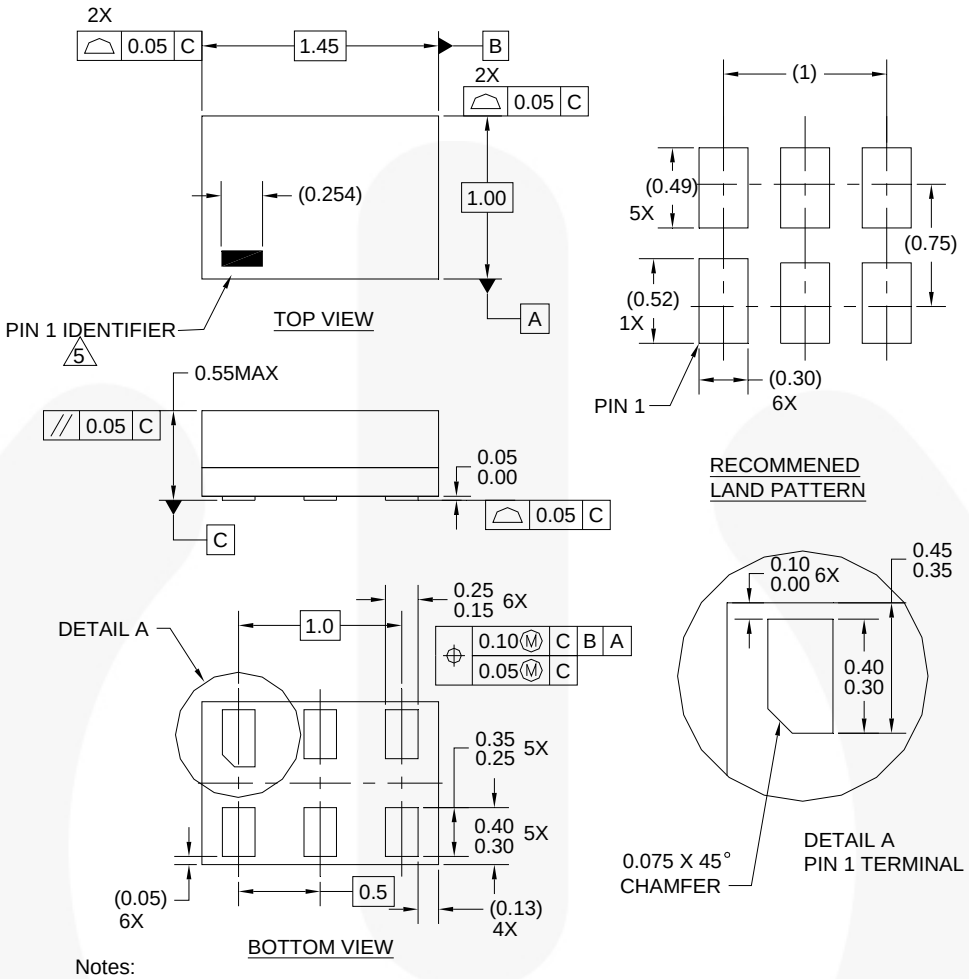
Tape and Reel Specification

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications:
http://www.fairchildsemi.com/products/analog/pdf/sc70-6_tr.pdf.

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
P6X	Leader (Start End)	125 (Typical)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

Physical Dimensions



Notes:

1. CONFORMS TO JEDEC STANDARD M0-252 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y14.5M-1994
4. FILENAME AND REVISION: MAC06AREV4
5. PIN ONE IDENTIFIER IS 2X LENGTH OF ANY OTHER LINE IN THE MARK CODE LAYOUT.

Figure 9. 6-Lead, MicroPak™, 1.0mm Wide

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Tape and Reel Specification

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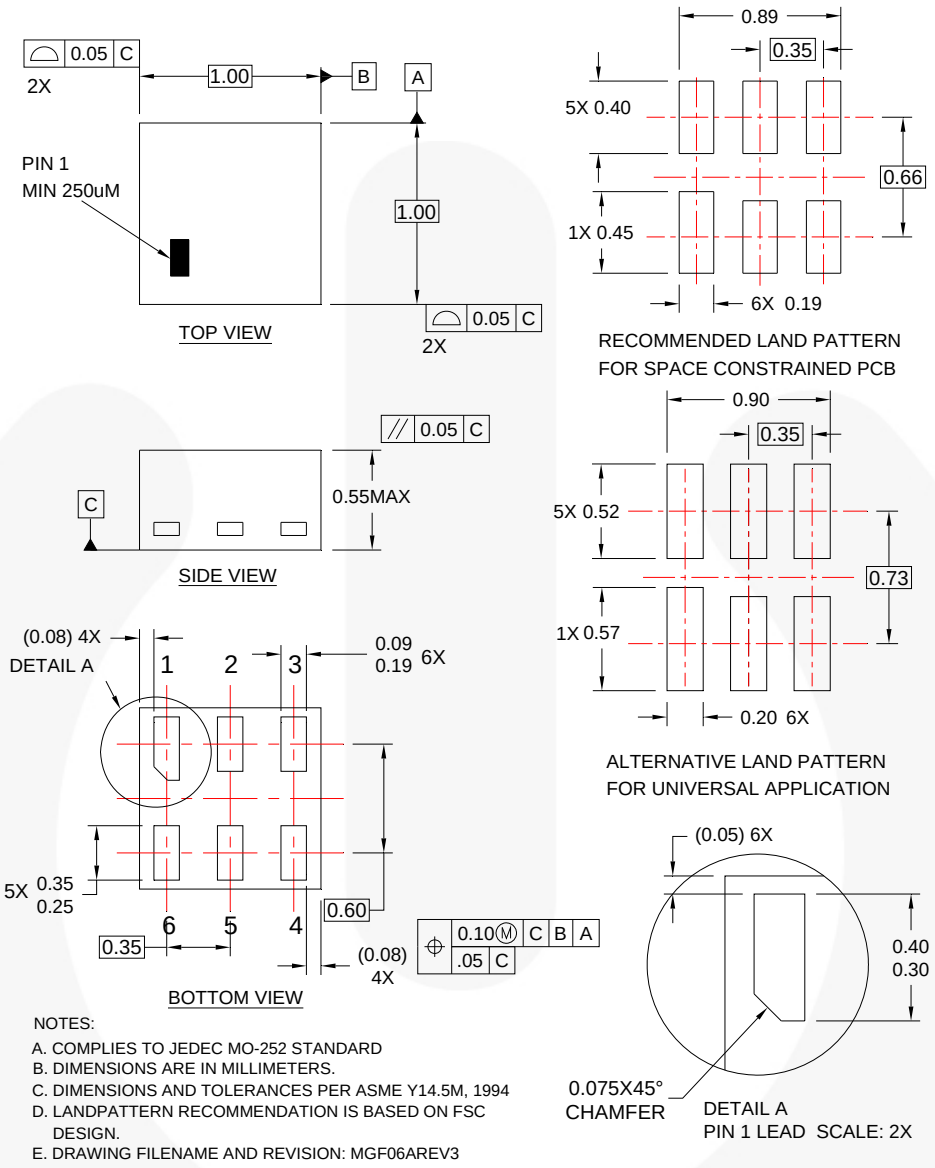
http://www.fairchildsemi.com/products/logic/pdf/micropak_tr.pdf.

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
L6X	Leader (Start End)	125 (Typical)	Empty	Sealed
	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

Physical Dimensions



NOTES:

A. COMPLIES TO JEDEC MO-252 STANDARD
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994
D. LANDPATTERN RECOMMENDATION IS BASED ON FSC DESIGN.
E. DRAWING FILENAME AND REVISION: MGF06AREV3

Figure 10. 6-Lead, MicroPak2, 1x1mm Body, .35mm Pitch

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Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
FHX	Leader (Start End)	125 (Typical)	Empty	Sealed
	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

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Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I55

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